

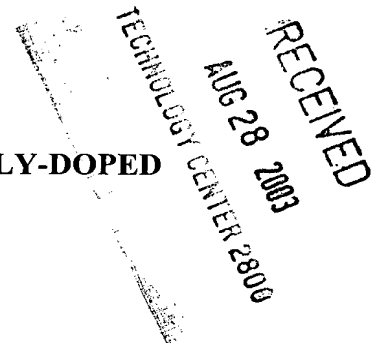


[10191/1993]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Richard SPITZ et al.
Serial No. : 09/914,404
Filed : December 13, 2001
For : **METHOD FOR PRODUCING HEAVILY-DOPED
SEMICONDUCTOR COMPONENTS**

Group Art Unit : 2823
Confirmation No. : 5115
Examiner : Michelle Estrada



Thereby certify that this correspondence is being deposited with the
United States Postal Service with sufficient postage as first class mail
in an envelope addressed to:
Mail Stop AF
Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450
on

MAIL STOP AF
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date: 8/21/2003

Signature: 

AARON C. DEDITCH
(33,865)

AMENDMENT AFTER FINAL OFFICE ACTION

S I R:

In response to the Final Office Action mailed on May 2, 2003 (the three-month response date for which has been extended by one month from August 2, 2003 to September 2, 2003 by the accompanying Transmittal And Petition To Extend), please reconsider the above-identified application based on the following:

Amendments to the Claims are reflected in the listing of the claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.

08/26/2003 SSITHIB1 00000122 110600 09914404

01 FC:1251 110.00 DA